R5540K SERIES

## N-channel Load Switch IC

No. EA-268-210705

## OUTLINE

The R5540 series are N-channel Load Switch ICs with the low supply current, Typ. $9 \mu \mathrm{~A}$. By using an Nch transistor as a driver transistor, the features of low on resistance and the reverse current protection at off state are realized in these ICs. The gate voltage of the N -channel transistor is supplied from the internal step-up circuit. The R5540 is an ideal switch to supply the power from the secondary power source such as the output of a step-down DC/DC to the load circuit. Since the package for the R5540 is the ultra small-sized DFN(PLP)1010-4F, high density mounting on board is possible.

## FEATURES

- Built-in an N-channel MOSFET
- Input Voltage Range 0.75 V to 3.6 V (Code 002)

- Supply Current at Operation (lout=0mA) $\cdots \cdots \cdots \cdots \cdots$ Typ. $9 \mu \mathrm{~A}$
- Supply Current at Standby Mode..................... Typ. $0.1 \mu \mathrm{~A}$
- Switch On Resistance ....................................................... 120mp (Vin $=1.2 \mathrm{~V}$ )


- Built-in Over- current Sensing Circuit $\ldots \ldots \ldots \ldots \ldots \ldots$................. $350 \mathrm{~mA} /$ TYP. 700 mA
- Built-in Soft-start function


## APPLICATION

- For secondary power source for electrical appliances such as mobile communication equipments, cameras, VCRs and Camcorders.


## BLOCK DIAGRAMS



## SELECTION GUIDE

The output current value, the auto-discharge function and the polarity of CE pin from "L" active, " H " active are selectable at the user's request.

| Product Name | Package | Quantity per Reel | Pb Free | Halogen Free |
| :---: | :---: | :---: | :---: | :---: |
| R5540Kxxx*-TR | DFN(PLP)1010-4F | $10,000 \mathrm{pcs}$ | Yes | Yes |

xxx: The output current value can be designated by the following codes.
002: Output Current (200mA)
004: Output Current ( 450 mA )
*: Auto-discharge function at off state and the polarity of CE pin are option as follows.
B: "H" active, without auto-discharge function at off state
C: "L" active, with auto-discharge function at off state
D: "H" active, with auto-discharge function at off state

## PIN CONFIGULATIONS



## PIN DESCRIPTION

R5540K : DFN(PLP)1010-4F

| Pin No | Symbol | Pin Description |
| :---: | :---: | :---: |
| 1 | GND | Ground Pin |
| 2 | $\overline{\mathrm{CE}} / \mathrm{CE}$ | Chip Enable Pin ("L" Active / "H" Active) |
| 3 | VIN | Input Pin |
| 4 | Vout | Output Pin |

## ABSOLUTE MAXIMUM RATINGS

| Symbol | Item | Rating | Unit |
| :---: | :--- | :---: | :---: |
| $\mathrm{V}_{\text {IN }}$ | Input Voltage | -0.3 to 5.0 | V |
| $\mathrm{~V}_{\text {CE }}$ | Input Voltage ( $\overline{\mathrm{CE}} /$ CE Pin) | -0.3 to 5.0 | V |
| Vout $^{\text {I }}$ | Output Voltage | -0.3 to 5.0 | V |
| lout | Output Current | Internally limited | mA |
| PD $^{\text {Pa }}$ | Power Dissipation <br> (Standard Test Land Pattern) |  |  |
| Ta | Ambient Tmeprature | 300 | mW |
| Tstg | Storage Temerature | -40 to 85 | ${ }^{\circ} \mathrm{C}$ |

*) For Power Dissipation, please refer to Power Dissipation to be described.

## ABSOLUTE MAXIMUM RATINGS

Electronic and mechanical stress momentarily exceeded absolute maximum ratings may cause the permanent damages and may degrade the life time and safety for both device and system using the device in the field. The functional operation at or over these absolute maximum ratings is not assured.

## RECOMMENDED OPERATING CONDITIONS (ELECTRICAL CHARACTERISTICS)

All of electronic equipment should be designed that the mounted semiconductor devices operate within the recommended operating conditions. The semiconductor devices cannot operate normally over the recommended operating conditions, even if when they are used over such conditions by momentary electronic noise or surge. And the semiconductor devices may receive serious damage when they continue to operate over the recommended operating conditions.

## ELECTRICAL CHARACTERISTICS

$\mathrm{V}_{\mathrm{IN}}=0.75$ to $3.60 \mathrm{~V}($ Code 002$), 0.80$ to $3.60 \mathrm{~V}($ Code 004$), \mathrm{C}_{\mathrm{IN}}=1 \mu \mathrm{~F}$, Cout $=$ None, unless otherwise noted.
The specification in surrounded by $\qquad$ is guaranteed by design at all temperature range, $-40^{\circ} \mathrm{C} \leq \mathrm{Ta} \leq 85^{\circ} \mathrm{C}$.


All test categories were tested on the units under the pulse load condition ( $\mathrm{T} j \approx \mathrm{Ta}=25^{\circ} \mathrm{C}$ ) except Short Current Response Time.
*Note1 $\overline{\mathrm{CE}}=\mathrm{L}$ for "L" active, $\mathrm{CE}=\mathrm{H}$ for "H" active
*Note2 $\overline{\mathrm{CE}}=\mathrm{H}$ for "L" active, $\mathrm{CE}=\mathrm{L}$ for " H " active

## TYPICAL APPLICATION



Basically, the R5540K series do not require a bypass capacitor between $\mathrm{V}_{\mathbb{I}}$ and GND, however, considering the spike noise caused by the high side inductor at current limit, use 0.1 uF or more capacitor as a bypass capacitor. More capacitance is also acceptable depending on the application.

## TYPICAL CHARACTERISTIC

1) Output Voltage vs. Output Current $\mathrm{C}_{\mathrm{IN}_{\mathrm{N}}}=1 \mathrm{uF}, \mathrm{C}_{\mathrm{out}}=1 \mathrm{uF}$

## R5540K002x



R5540K004x

2) Turn on waveform ( $002 \mathrm{x}, \mathrm{V}_{\mathrm{IN}}=1.2 \mathrm{~V}, \mathrm{C}_{\mathrm{IN}}=1 \mathrm{uF}, \mathrm{Ta}=25^{\circ} \mathrm{C}$ )





3) Inrush current vs. output capacitor (002x)

5) Supply current vs. Temperature

7) Standby Current vs. Temperature

4) Input voltage vs. Turn-on speed

6) Standby current vs. Input voltage

8) Standby current vs. Input voltage

9) CE Input voltage "H" vs. Temperature

11) CE Input voltage "L" vs. Temperature

13) Short current limit vs. Temperature

15) Switch on resistance vs. Temperature

10) CE Input voltage "H" vs. VDD

12) CE Input voltage "L" vs. VDD

14) Short current limit vs. Input voltage

16) Switch on resistance vs. Input voltage

RON vs VIN

17) Output Rise time vs. Temperature

19) Output Fall time vs. Temperature

21) Reverse leakage current vs. Temperature

18) Output Rise time vs. Input voltage

20) Output Fall time vs. Input voltage

22) Reverse leakage current vs. Input voltage

23) Discharge resistance vs. Temperature

25) Current limit vs. Temperature (002x)

24) Discharge resistance vs. Input voltage

26) Current limit vs. Input voltage (002x)


## TIMING CHART



Turn-on/ turn-off waveform ( $\mathrm{V}_{\mathrm{IN}}=1.2[\mathrm{~V}]$ )





## POWER DISSIPATION (DFN(PLP)1010-4F)

Power Dissipation $\left(P_{D}\right)$ depends on conditions of mounting on board. This specification is based on the measurement at the condition below:

Measurement Conditions

|  | Standard Land Pattern |
| :---: | :---: |
| Environment | Mounting on Board (Wind velocity=0m/s) |
| Board Material | Glass cloth epoxy plastic (Double sided) |
| Board Dimensions | $40 \mathrm{~mm} \times 40 \mathrm{~mm} \times 1.6 \mathrm{~mm}$ |
| Copper Ratio | Top side: Approx. $50 \%$, Back side: Approx. $50 \%$ |
| Through-holes | $\phi 0.54 \mathrm{~mm} \times 24 \mathrm{pcs}$ |

Measurement Result
$\left(\mathrm{Ta}=25^{\circ} \mathrm{C}, \mathrm{Tjmax}=125^{\circ} \mathrm{C}\right)$

|  | Standard Land Pattern |
| :---: | :---: |
| Power Dissipation | 300 mW |
| Thermal Resistance | $\theta \mathrm{ja}=\left(125-25^{\circ} \mathrm{C}\right) / 0.3 \mathrm{~W}=330^{\circ} \mathrm{C} / \mathrm{W}$ |
|  | $\theta \mathrm{jc}=48^{\circ} \mathrm{C} / \mathrm{W}$ |



Power Dissipation


Measurement Board Pattern

IC Mount Area (Unit : mm)

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